ABSOLUTE MAXIMUM RATINGS

PVDD to PGND+16V V _{DD} to GND+4V
FB_, SYNCOUT, SYNC, SDA/VOL, ADDR1,
ADDR2 to GND0.3V to (V _{DD} + 0.3V)
BOOT_ to VDD0.3V to +6V
BOOT_ to OUT0.3V to +6V
OUT_ to GND0.3V to (PVDD + 0.3V)
PGND to GND0.3V to +0.3V
Any Other Pin to GND0.3V to +4V
OUT_, Short-Circuit DurationContinuous
Continuous Power Dissipation ($T_A = +70^{\circ}C$)
44-Pin Thin QFN (derate 27mW/°C above +70°C,
single-layer board)2162mW

44-Pin Thin QFN (derate 37mW/°C above -	+70°C,
multilayer board)	2963mW
θJA, Single-Layer Board	37°C/W
θJA, Multilayer Board	27°C/W
Continuous Input Current (PVDD, PGND)	
Continuous Output Current (OUT_)	3.2A
Continuous Input Current (except OUT_)	±20mA
Junction Temperature	+150°C
Operating Temperature Range	40°C to +85°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C

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Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{PVDD} = 12V, V_{DD} = 3.3V, V_{GND} = V_{PGND} = 0V, V_{MUTE} = 0V; max volume setting; all speaker load resistors connected between OUT_+ and OUT_-, R_L = ∞ , unless otherwise stated, C_{BOOT} = 0.1µF, C_{BIAS} = 2.2µF, C_{IN} = 0.47µF, R_{IN} = 20k Ω , R_F = 20k Ω , spreadspectrum mode, filterless modulation mode, see the Functional Diagrams/Typical Application Circuits. TA = TMIN to TMAX, unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$.) (Note 1)

PARAMETER	SYMBOL	c	ONDITIONS	MIN	ТҮР	MAX	UNITS
GENERAL							
Speaker Amplifier Supply Voltage Range	PVDD	Inferred from PS	SRR test	4.5		14	V
Supply Voltage Range	V _{DD}	Inferred from PS	Inferred from PSRR test			3.6	V
Quiescent Current	IDD				20	35	mA
Quescent Current	Ipvdd				10	20	ША
Shutdown Current	IVDDSHDN	$T_A = +25^{\circ}C$			0.1	1	μA
Shutdown Current	I PVDDSHDN	$T_A = +25^{\circ}C$			0.1	1	μΑ
Turn-On Time	ton				200		ms
Common-Mode Bias Voltage	VBIAS				1.5		V
Input Amplifier Output-Voltage Swing High	VOH	Specified as $V_{DD} - V_{OH}$, $R_L = 2k\Omega$ connected to 1.5V			20		mV
Input Amplifier Output-Voltage Swing Low	V _{OL}	Specified as V_{OL} – GND, R_L = 2k Ω connected to 1.5V			20		mV
Input Amplifier Output Short- Circuit Current Limit					±60		mA
Input Amplifier Gain-Bandwidth Product	GBW				1.8		MHz
SPEAKER AMPLIFIERS							
Gain	Δυσταγ	Maximum	Output stage gain		29.5		dB
Gain	Avmax	volume setting	Total gain (Note 2)		29.5		ub
Output Offset	Vos	$T_A = 25^{\circ}C$			±2	±15	mV

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{PVDD} = 12V, V_{DD} = 3.3V, V_{GND} = V_{PGND} = 0V, V_{MUTE} = 0V; max volume setting; all speaker load resistors connected between OUT_+ and OUT_-, R_L = <math>\infty$, unless otherwise stated, C_{BOOT} = 0.1µF, C_{BIAS} = 2.2µF, C_{IN} = 0.47µF, R_{IN} = 20k Ω , R_F = 20k Ω , spread-spectrum mode, filterless modulation mode, see the *Functional Diagrams/Typical Application Circuits*. T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CC	ONDITIONS	MIN	ТҮР	MAX	UNITS	
			$P_{OUT} = 10W, f_{IN} = 1kHz, 8\Omega$ load		93		%	
Efficiency (Note 3)			$P_{OUT} = 15W, f_{IN} = 1kHz, 4\Omega$ load		87		%	
Eliciency (Note 3)	η		$P_{OUT} = 10W, f_{IN} = 1kHz, 8\Omega$ load		92		~ %	
			$P_{OUT} = 15W, f_{IN} = 1kHz, 4\Omega$ load		88		/0	
			$R_L = 8\Omega$, THD+N = 1%		1.4			
		V _{PVDD} = 5V,	$R_L = 8\Omega$, THD+N = 10%		1.8			
		$f_{IN} = 1 kHz$	$R_L = 4\Omega$, THD+N = 1%		2.6			
			$R_L = 4\Omega$, THD+N = 10%		3.6			
			$R_L = 8\Omega$, THD+N = 1%		8			
Output Power	Роит	, ,	$R_L = 8\Omega$, THD+N = 10%		10		W	
Output i owei	1001	f _{IN} = 1kHz	$R_L = 4\Omega$, THD+N = 1%		14		**	
			$R_L = 4\Omega$, THD+N = 10%		17			
		$f_{IN} = 1 \text{kHz}$	$R_L = 8\Omega$, THD+N = 1%		10			
			$R_L = 8\Omega$, THD+N = 10%		13			
			$R_L = 4\Omega$, THD+N = 1%		17.5			
			$R_L = 4\Omega$, THD+N = 10%		22.5			
Hard Output Current Limit	I _{SC}			3.9	5.5		А	
Total Harmonic Distortion Plus		f = 1 kHz, RL =	Filterless modulation		0.04			
Noise	THD+N	8Ω , $P_{OUT} = 5W$, $f_{IN} = 1kHz$	PWM		0.04		%	
		P _{OUT} = 10W,	Fixed-frequency modulation, unweighted		91		-	
		$R_L = 8\Omega,$ filterless	Spread-spectrum, unweighted		90			
Signal-to-Noise Ratio		modulation mode, BW =	Fixed-frequency modulation, A-weighted		94		- dB	
		22Hz to 22kHz	Spread-spectrum, A-weighted		94			
	SNR		Fixed-frequency modulation, unweighted		91		1	
		$P_{OUT} = 10W,$ $R_{L} = 8\Omega, PWM$	Spread-spectrum, unweighted		81		1	
		mode, BW = $22Hz$ to $22kHz$	Fixed-frequency modulation, A-weighted		94		dB	
			Spread-spectrum, A-weighted		89			



ELECTRICAL CHARACTERISTICS (continued)

 $(V_{PVDD} = 12V, V_{DD} = 3.3V, V_{GND} = V_{PGND} = 0V, V_{MUTE} = 0V; max volume setting; all speaker load resistors connected between OUT_+ and OUT_-, R_L = <math>\infty$, unless otherwise stated, C_{BOOT} = 0.1µF, C_{BIAS} = 2.2µF, C_{IN} = 0.47µF, R_{IN} = 20k Ω , R_F = 20k Ω , spread-spectrum mode, filterless modulation mode, see the *Functional Diagrams/Typical Application Circuits*. T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDI	TIONS	MIN	ТҮР	MAX	UNITS	
		1kHz			85			
Crosstalk		20Hz to 20kHz			68		dB	
		$V_{DD} = 2.7V$ to 3.6V, T _A MUTE = high	4 = 25°C,		68			
Power-Supply Rejection Ratio	PSRR	$PV_{DD} = 4.5V$ to $14V$	PV _{DD} = 4.5V to 14V		83		dB	
		f = 1kHz, VRIPPLE = 10	0mV _{P-P} on V _{DD}		70			
		f = 1kHz, V _{RIPPLE} = 20	0mV _{P-P} on PVDD		75			
		SYNC = GND		1020	1200	1355		
SVNC Eroquopov	forme	SYNC = unconnected		1280	1440	1640	kHz	
SYNC Frequency	fsync	SYNC = V _{DD} (spread-	spectrum mode)		1200 ±30		КПИ	
		SYNC = GND		255	300	338		
Class D Switching Frequency	four	SYNC = unconnected		320	360	410		
Class D Switching Frequency	ass D Switching Frequency f_{SW} SYNC = V_{DD} (spread-spectrum mode)		spectrum mode)		300 ±6		kHz	
SYNC Frequency Lock Range				1000		1600	kHz	
Minimum SYNC Frequency Lock Duty Cycle					40		%	
Maximum SYNC Frequency Lock Duty Cycle					60		%	
Gain Matching		Full volume (ideal mate	ching for R _{IN} and R _F)		0.2		dB	
		Peak voltage, 32	Into shutdown		-43		dBV	
Oligit and Dan Laval			Out of shutdown		-43			
Click-and-Pop Level	KCP	samples/second, A-weighted (Note 4)	Into mute		-46			
		······g····· (······ ·)	Out of mute		-57			
VOLUME CONTROL								
VOL Input Leakage Current					±5		μA	
Input Hysteresis		DC volume control mo	de		11		mV	
9.5dB Gain Voltage		DC volume control mode			0.1 x V _{DD}		V	
Full Mute Voltage		DC volume control mode			0.9 x V _{DD}		V	
Full Mute Attenuation		f = 1kHz, relative to 9.5	5dB setting		-115		dB	
DIGITAL INPUTS/OUTPUT (SHDN	Ī, MUTE, ADI	DR1, ADDR2, SCLK, SD	A/VOL)					
Input-Voltage High	VIH			$0.7 \times V_D$	D		V	
Input-Voltage Low	VIL				C).3 x V _{DD}	V	
Input Leakage Current	I _{LK}	$T_A = +25^{\circ}C$				±1	μΑ	
Input Hysteresis		SCLK, SDA/VOL			0.1 x V _{DD}		V	
Input Capacitance	CIN				5		рF	
Output-Voltage Low	VIL	I _{OL} = 3mA				0.4	V	

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ELECTRICAL CHARACTERISTICS (continued)

 $(V_{PVDD} = 12V, V_{DD} = 3.3V, V_{GND} = V_{PGND} = 0V, V_{MUTE} = 0V$; max volume setting; all speaker load resistors connected between OUT_+ and OUT_-, RL = ∞ , unless otherwise stated, $C_{BOOT} = 0.1\mu$ F, $C_{BIAS} = 2.2\mu$ F, $C_{IN} = 0.47\mu$ F, $R_{IN} = 20k\Omega$, $R_F = 20k\Omega$, spread-spectrum mode, filterless modulation mode, see the *Functional Diagrams/Typical Application Circuits*. T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
DIGITAL INPUT (SYNC)						
Input-Voltage High	VSYNCIH		2.3			V
Input-Voltage Low	VSYNCIL				0.8	V
SYNC Input Leakage	ISYNCIN	$T_A = +25^{\circ}C$	±7.5		±13	μA
DIGITAL OUTPUT (SYNCOUT)		<u>.</u>	·			
Output-Voltage High	Vsyncoutih	ISOURCE = 1mA	V _{DD} - 0.3			V
Output-Voltage Low	VSYNCOUTIL	I _{SINK} = 1mA			0.3	V
Rise/Fall Time		C _L = 10pF		50		V/µs
THERMAL PROTECTION	•					
Thermal-Shutdown Threshold				+165		°C
Thermal-Shutdown Hysteresis				15		°C
I ² C TIMING CHARACTERISTICS	(Figure 3)	•				•
Serial Clock	fscl				400	kHz
Bus Free Time Between a STOP and a START Condition	^t BUF		1.3			μs
Hold Time (Repeated) START Condition	^t HD, STA	(Note 5)	0.6			μs
Repeated START Condition Setup Time	tsu, sta		0.6			μs
STOP Condition Setup Time	ts∪, sto		0.6			μs
Data Hold Time	thd,dat		0		0.9	μs
Data Setup Time	tsu,dat		100			ns
SCL Clock Low Period	tLOW		1.3			μs
SCL Clock High Period	thigh		0.6			μs
Rise Time of SDA and SCL, Receiving	t _R	(Note 6)	20 + 0.1C _B		300	ns
Fall Time of SDA and SCL, Receiving	tF	(Note 6)	20 + 0.1C _B		300	ns
Pulse Width of Spike Suppressed	tsp		0		50	ns
Capacitive Load for Each Bus Line	CB				400	pF

Note 1: All devices are 100% production tested at +25°C. All temperature limits are guaranteed by design.

Note 2: See the *Gain-Setting Resistors* section.

Note 3: Measured on the MAX9744 Evaluation Kit.

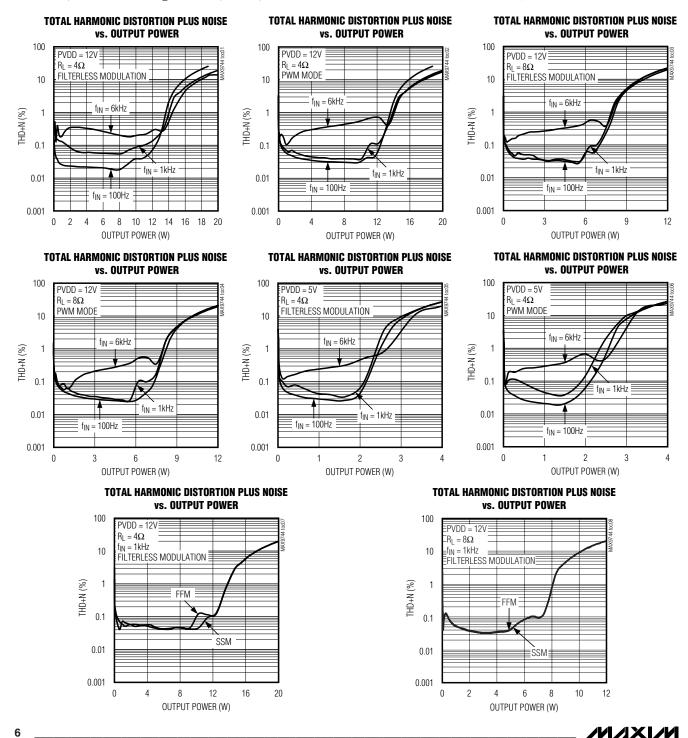
Note 4: Testing performed with an 8Ω resistive load connected across BTL output. Mode transitions are controlled by SHDN or MUTE pin, respectively.

Note 5: A master device must provide a hold time of at least 300ns for the SDA signal in order to bridge the undefined region of the SCL's falling edge.

Note 6: C_B = total capacitance of one bus line in pF.

Typical Operating Characteristics

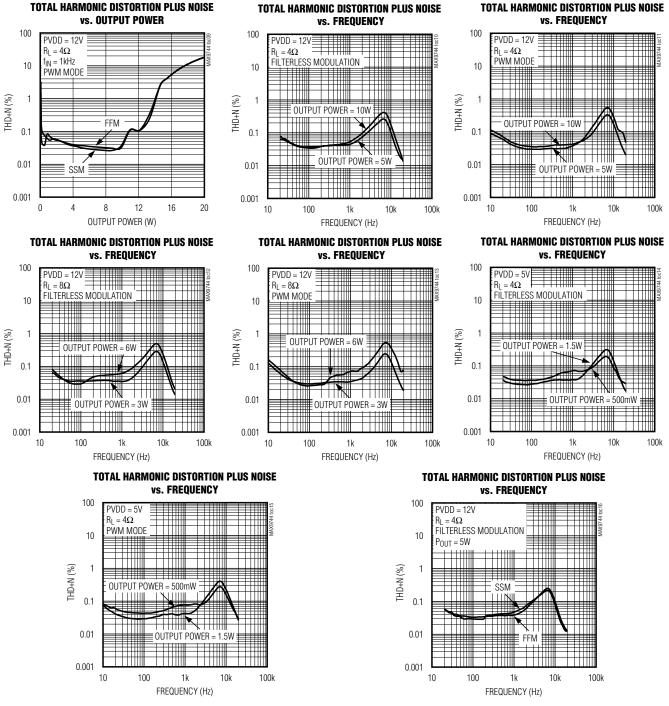
 $(V_{PVDD} = 12V, V_{DD} = 3.3V, V_{GND} = V_{PGND} = 0V, V_{MUTE} = 0V; max volume setting; all speaker load resistors connected between OUT_+ and OUT_- with an inductor in series, 8<math>\Omega$ load, L = 68 μ H, 4 Ω load, L= 33 μ H. R_L = ∞ , unless otherwise stated, C_{BIAS} = 2.2 μ F, C_{IN} = 0.47 μ F, R_{IN} = 20k Ω , R_F = 20k Ω , spread-spectrum mode, T_A = +25°C, unless otherwise noted.)



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_Typical Operating Characteristics (continued)

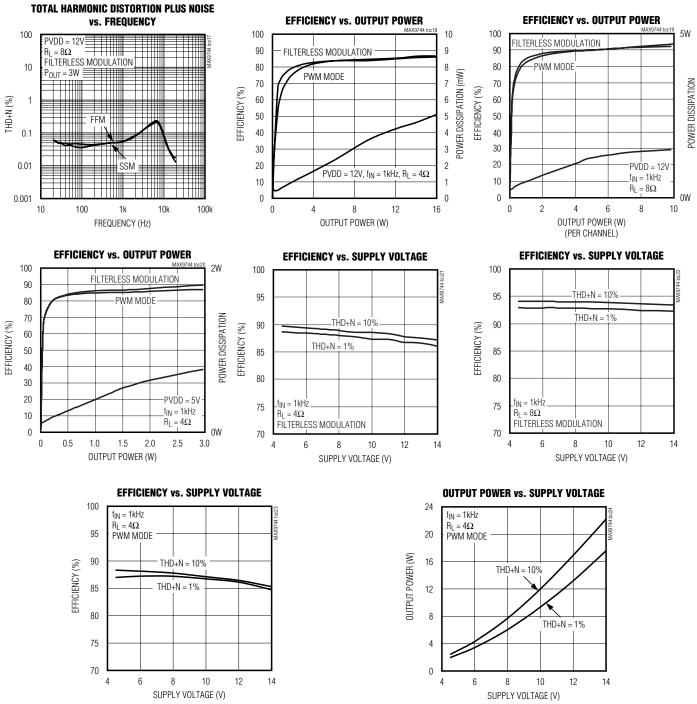
 $(V_{PVDD} = 12V, V_{DD} = 3.3V, V_{GND} = V_{PGND} = 0V, V_{MUTE} = 0V; max volume setting; all speaker load resistors connected between OUT_+ and OUT_- with an inductor in series, 8<math>\Omega$ load, L = 68 μ H, 4 Ω load, L = 33 μ H. R_L = ∞ , unless otherwise stated, C_{BIAS} = 2.2 μ F, C_{IN} = 0.47 μ F, R_{IN} = 20k Ω , R_F = 20k Ω , spread-spectrum mode, T_A = +25°C, unless otherwise noted.)



///XI//

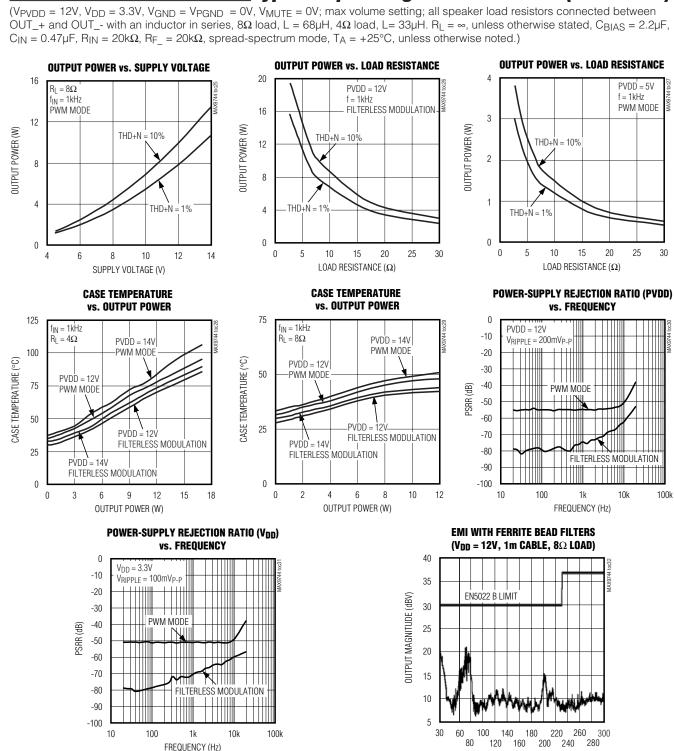
Typical Operating Characteristics (continued)

 $(V_{PVDD} = 12V, V_{DD} = 3.3V, V_{GND} = V_{PGND} = 0V, V_{MUTE} = 0V; max volume setting; all speaker load resistors connected between OUT_+ and OUT_- with an inductor in series, 8<math>\Omega$ load, L = 68 μ H, 4 Ω load, L = 33 μ H. R_L = ∞ , unless otherwise stated, C_{BIAS} = 2.2 μ F, C_{IN} = 0.47 μ F, R_{IN} = 20k Ω , R_F = 20k Ω , spread-spectrum mode, T_A = +25°C, unless otherwise noted.)



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Typical Operating Characteristics (continued)

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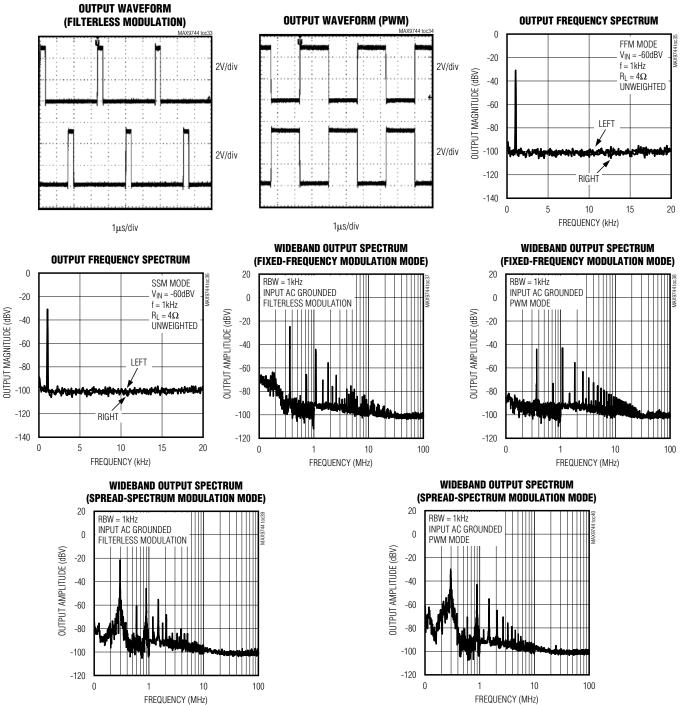
FREQUENCY (MHz)

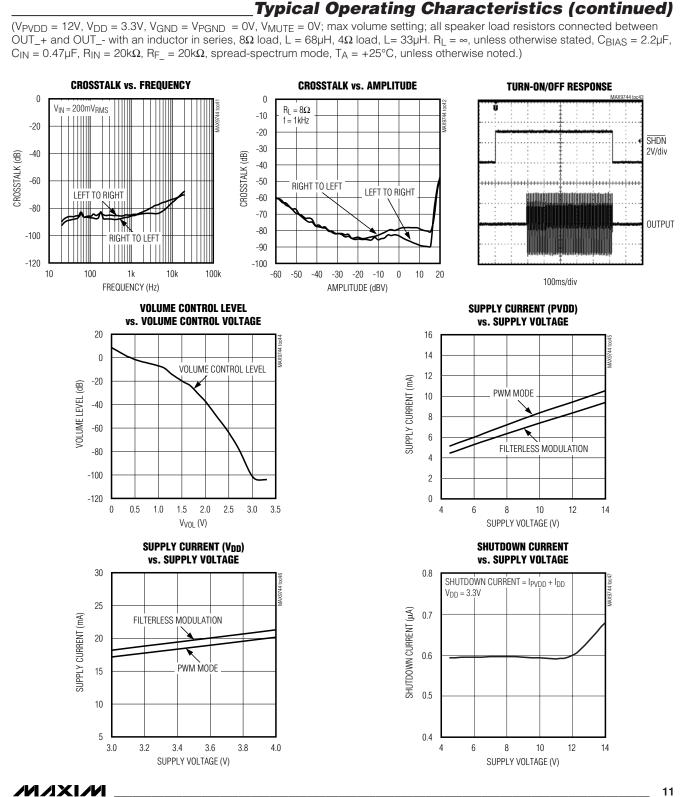
MAX9744

Typical Operating Characteristics (continued)

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 $(V_{PVDD} = 12V, V_{DD} = 3.3V, V_{GND} = V_{PGND} = 0V, V_{MUTE} = 0V; max volume setting; all speaker load resistors connected between OUT_+ and OUT_- with an inductor in series, 8<math>\Omega$ load, L = 68 μ H, 4 Ω load, L = 33 μ H. R_L = ∞ , unless otherwise stated, C_{BIAS} = 2.2 μ F, C_{IN} = 0.47 μ F, R_{IN} = 20k Ω , R_F = 20k Ω , spread-spectrum mode, T_A = +25°C, unless otherwise noted.)





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MAX9744

Pin Description

PIN	NAME	FUNCTION
1	BOOTL+	Left-Channel Positive Speaker Output Boost Flying-Capacitor Connection. Connect a 0.1µF ceramic capacitor between BOOTL+ and OUTL+.
2, 3	OUTL+	Left-Channel Speaker Output, Positive Phase
4, 5, 29, 30	PVDD	Speaker Amplifier Power-Supply Input. Bypass each with a 1µF capacitor to PGND.
6, 10, 21, 28	V _{DD}	Power-Supply Input. Bypass each with a 1µF capacitor to GND.
7, 11, 12, 15, 27	GND	Ground
8	SDA/VOL	I ² C Serial Data I/O and Analog Volume Control Input
9	SCLK/PWM	I^2C Serial Clock Input and Modulation Scheme Select. In I^2C mode (ADDR1 and ADDR2 \neq GND), acts as I^2C serial clock input. When ADDR1 and ADDR2 = GND, set SCLK = 1 for standard PWM output scheme, or set SCLK = 0 for filterless modulation output scheme.
13	ADDR1	Address Select Input 1. Sets device address for I ² C address option. Connect ADDR1 and ADDR2 to GND to select analog volume control mode.
14	ADDR2	Address Select Input 2. Sets device address for I ² C address option. Connect ADDR1 and ADDR2 to GND to select Analog Volume Control mode.
16	INL	Left-Channel Audio Input
17	FBL	Left-Channel Feedback. Connect feedback resistor between FBL and INL to set amplifier gain. See the <i>Gain-Setting Resistors</i> section.
18	FBR	Right-Channel Feedback. Connect feedback resistor between FBR and INR to set amplifier gain. See the <i>Gain-Setting Resistors</i> section.
19	INR	Right-Channel Input
20	BIAS	Common-Mode Bias Voltage. Bypass with a 2.2µF capacitor to GND.
22	SHDN	Shutdown Input. Drive $\overline{\text{SHDN}}$ low to disable the audio amplifiers. Connect $\overline{\text{SHDN}}$ to V_{DD} or drive high for normal operation.
23	N.C.	No Connection. Not internally connected.
24	MUTE	Mute Input. Drive MUTE high to mute the speaker outputs. Connect MUTE to GND for normal operation (mute function controls speaker outputs only).
25	25 SYNC SYNC = GND: Fixed-frequency mode with f _{SYNC} = 1200kHz SYNC = Unconnected: Fixed-frequency mode with f _{SYNC} = 1440kHz SYNC = V _{DD} : Spread-spectrum mode with f _{SYNC} = 1200kHz ±30kHz SYNC = Clocked: Fixed-frequency mode with f _{SYNC} = external clock frequency value of f _{SYNC} .	

Pin Description (continued)

PIN	NAME	FUNCTION			
26	SYNCOUT	/NC Signal Output			
31, 32	OUTR+	Right-Channel Positive Speaker Output			
33	BOOTR+	Right-Channel Positive Speaker Output Boost Flying-Capacitor Connection. Connect a 0.1μ F ceramic capacitor between BOOTR+ and OUTR+.			
34, 35, 39, 43, 44	PGND	Power Ground			
36, 37	OUTR-	Right-Channel Negative Speaker Output			
38	BOOTR-	Right-Channel Negative Speaker Output Boost Flying-Capacitor Connection. Connect a 0.1µF ceramic capacitor between BOOTR- and OUTR			
40	BOOTL-	Left-Channel Negative Speaker Output Boost Flying-Capacitor Connection. Connect a 0.1μ F ceramic capacitor between BOOTL- and OUTL			
41, 42	OUTL-	Left-Channel Negative Speaker Output			
_	EP	Exposed Pad. The external pad lowers the package's thermal impedance by providing a direct heat conduction path from the die to the PCB. Connect the exposed thermal pad to PGND.			

Detailed Description

The MAX9744 20W filterless, stereo Class D audio power amplifier offers Class AB performance with Class D efficiency with a minimal board space solution. The MAX9744 features a spread-spectrum modulation scheme offering significant improvements to switchmode amplifier technology. This device features analog or digitally adjustable volume control, externally set input gain, shutdown mode, SYNC input and output, mute, and industry-leading click-and-pop suppression.

The MAX9744 features extensive click-and-pop suppression circuitry that eliminates audible clicks-and-pops at startup and shutdown.

The MAX9744 features a 64-step, dual-mode (analog or I²C) volume control and mute function. In analog volume control mode, the voltage applied to SDA/VOL sets the volume level. Two address inputs (ADDR1, ADDR2) set the volume control function between analog and I²C mode and set the slave address. In I²C mode, there are three selectable slave addresses allowing for multiple devices on a single bus.

The MAX9744 offers spread-spectrum and fixed-frequency modes of operation with classic PWM or filterless modulation output schemes. The filterless modulation scheme uses minimum pulse outputs when the audio inputs are at the zero crossing. As the input voltage increases or decreases, the duration of the pulse at one output increases while the other output pulse duration remains the same. This causes the net voltage across the speaker (V_{OUT+} - V_{OUT-}) to change. The minimum-width pulse topology reduces EMI and increases efficiency.

Operating Modes

Fixed-Frequency Modulation Mode

The MAX9744 features two fixed-frequency modes: 300kHz and 360kHz. Connect SYNC to GND to select 300kHz switching frequency; leave SYNC unconnected to select the 360kHz switching frequency. The MAX9744 frequency spectrum consists of the fundamental switching frequency and its associated harmonics (see the Wideband Output Spectrum graphs in the *Typical Operating Characteristics*). For applications where exact spectrum placement of the switching frequency so that the harmonics do not fall within a sensitive frequency band (Table 1). Audio reproduction is not affected by changing the switching frequency.



Spread-Spectrum Modulation Mode

The MAX9744 features a unique spread-spectrum mode that flattens the wideband spectral components, improving EMI emissions that may be radiated by the speaker and cables. This mode is enabled by setting SYNC = V_{DD} (Table 1). In spread-spectrum mode, the switching frequency varies randomly by ±7.5kHz around the center frequency (300kHz). The modulation scheme remains the same, but the period of the triangle waveform changes from cycle to cycle. Instead of a large amount of spectral energy present at multiples of the switching frequency, the energy is now spread over a bandwidth that increases with frequency. Above a few megahertz, the wideband spectrum looks like white noise for EMI purposes. A proprietary amplifier topology ensures this does not corrupt the noise floor in the audio bandwidth.

External Clock Mode

The SYNC input allows the MAX9744 to be synchronized to an external clock or another Maxim Class D amplifier, creating a fully synchronous system. This minimizes clock intermodulation and allocates spectral components of the switching harmonics to insensitive frequency bands. Applying a clock signal between 1MHz and 1.6MHz to SYNC synchronizes the MAX9744. The MAX9744 Class D amplifier operates at 1/4 of the SYNC frequency. For example, if SYNC is 1.6MHz, the Class D amplifier operates at 400kHz.

The external SYNC signal can be any CMOS clock source with a 40% to 60% duty cycle. Spread-spectrum clocks work well to reduce EMI; therefore, the SYNCOUT signal from another MAX9744 in spreadspectrum mode is an excellent SYNC input.

SYNC	MODE	fsync (kHz)	f _{SW} (kHz)
GND	Fixed-frequency modulation	1200	300
Unconnected	Fixed-frequency modulation	1440	360
V _{DD}	Spread-spectrum modulation	1200 ±30	300 ±7.5
Clocked	EXT	1000 to 1600	250 to 400

Table 1. Operating Modes

SYNCOUT allows several Maxim amplifiers to be cascaded (Figure 1). The synchronized output minimizes interference due to clock intermodulation caused by the switching spread between single devices. Using SYNCOUT and SYNC does not affect the audio performance of the MAX9744.

Filterless Modulation/PWM Modulation

The MAX9744 features two output modulation schemes: filterless modulation or classic PWM. The MAX9744 output modulation schemes are selectable through SCLK/PWM when the device is in analog mode (ADDR1 and ADDR2 = GND, Table 2) or through the I²C interface (Table 8). Maxim's unique, filterless modulation scheme eliminates the LC filter required by traditional Class D amplifiers, reducing component count and conserving board space and system cost. Although the MAX9744 meets FCC and other EMI limits with a lowcost ferrite bead filter, many applications still may want to use a full LC-filtered output. If using a full LC filter, audio performance is best with the MAX9744 configured for classic PWM output.

Switching between schemes, the output is not click-andpop protected. To have click-and-pop protection when switching between output schemes, the device must enter shutdown mode and be configured to the new output scheme before the startup sequence is finished.

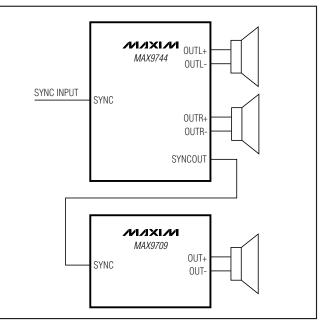


Figure 1. Cascading Two Amplifiers' External Clock Mode

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Table 2. Modulation Scheme Selection

ADDR2	ADDR1	SDA/VOL	SCLK/PWM	FUNCTION
0	0	Analog volume control	0	Filterless modulation
0	0	Analog volume control	1	Classic PWM (50% duty cycle)

Efficiency

The high efficiency of a Class D amplifier is due to the switching operation of the output stage transistors. In a Class D amplifier, the output transistors act as current-steering switches and consume negligible additional power. Any power loss associated with the Class D output stage is mostly due to the I²R loss of the MOSFET on-resistance, and quiescent current overhead.

The theoretical best efficiency of a linear amplifier is 78% at peak output power. Under normal operating levels (typical music reproduction levels), the efficiency falls below 30%, whereas the MAX9744 exhibits > 80% efficiency under the same conditions (Figure 2).

Current Limit When the output current exceeds the current limit, 5.5A (typ), the MAX9744 disables the outputs and initiates a 220µs startup sequence. The shutdown and startup sequence is repeated until the output fault is removed. Since the retry repetition is slow, the average supply current is low. Most applications do not enter currentlimit mode unless the output is short circuited or incorrectly connected.

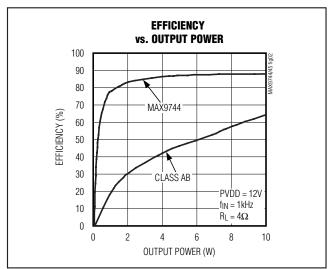


Figure 2. MAX9744 Efficiency vs. Class AB Efficiency



Thermal Shutdown

When the die temperature exceeds the thermal-shutdown threshold, +165°C (typ), the MAX9744 outputs are disabled. Normal operation resumes when the die temperature decreases by a factor equal to the thermal-shutdown threshold minus the thermal-shutdown hysteresis, (typically below +150°C). The effect of thermal shutdown is an output signal turning off for approximately 3s in most applications, depending on the thermal time constant of the audio system. Most applications should never enter thermal shutdown. Some of the possible causes of thermal shutdown are too low of a load impedance, bad thermal contact between the MAX9744's exposed pad and PCB, high ambient temperature, poor PCB layout and assembly, or excessive output overdrive.

Shutdown

The MAX9744 features a shutdown mode that reduces power consumption and extends battery life. Driving SHDN low places the device in low-power shutdown mode. Connect SHDN to digital high for normal operation. In shutdown mode, the outputs are high impedance, SYNCOUT is pulled high, BIAS voltage decays to zero, and the common-mode input voltage decays to zero. The I²C register does not retain its contents during shutdown (MAX9744).

Mute Function

The MAX9744 features a clickless-and-popless mute mode. When the device is muted, the outputs do not stop switching; only the volume level is muted to the speaker. Mute only affects the output stage and does not shut down the device. To mute the MAX9744, drive MUTE to logic-high. MUTE should be held high during system power-up and power-down to ensure that pops caused by circuits before the MAX9744 are eliminated. To reduce clicks and pops, the device enters or exits mute at zero crossing.

Volume Control

For maximum flexibility, the MAX9744 features volume control operation using an analog voltage input or through the I²C interface. To set the device to analog mode, connect ADDR1 and ADDR2 to GND. In analog mode, SDA/VOL is an analog input for volume control. The analog input range is ratiometric between 0.9 x V_{DD} and 0.1 x V_{DD} where 0.9 x V_{DD} = full mute and 0.1 x V_{DD} = full volume (Table 7).

Use ADDR1 and ADDR2 to select I²C mode. There are three addresses that can be chosen, allowing for multiple devices on a single bus (Table 4). In I²C mode, volume is controlled by choosing the speaker volume control register in the command byte (Table 5). There are 64 volume settings, where the lowest setting is full mute (Table 6). See the *Write Byte* section for more information on formatting data and tables to set volume levels. The default volume after power-up is position 40 (-7.1dB) (see Table 7).

I²C Interface The MAX9744 features an I²C 2-wire serial interface consisting of a serial-data line (SDA) and a serial-clock line (SCL). SDA and SCL facilitate communication between the MAX9744 and the master at clock rates up to 400kHz. Figure 3 shows the 2-wire interface timing diagram. The MAX9744 is a receive-only slave device, relying on the master to generate the SCL signal. The MAX9744 cannot write to the SDA bus except to acknowledge the receipt of data from the master. The master, typically a microcontroller, generates SCL and initiates data transfer on the bus.

A master device communicates to the MAX9744 by transmitting the proper address followed by the data word. Each transmit sequence is framed by a START (S) or Repeated START (Sr) condition and a STOP (P) condition. Each word transmitted over the bus is 8 bits long and is always followed by an acknowledge clock pulse.

The MAX9744 SDA line operates as both an input and an open-drain output. A pullup resistor, greater than 500Ω , is required on the SDA bus. The MAX9744 SCL line operates as an input only. A pullup resistor, greater than 500Ω , is required on SCL if there are multiple masters on the bus, or if the master in a single-master system has an open-drain SCL output. Series resistors in line with SDA and SCL are optional. The SCL and SDA inputs have Schmitt trigger and filter circuits that suppress noise spikes to assure proper device operation even on a noisy bus.

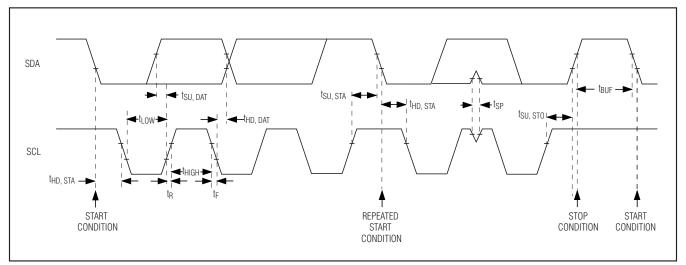


Figure 3. 2-Wire Serial-Interface Timing Diagram

Bit Transfer

One data bit is transferred during each SCL cycle. The data on SDA must remain stable during the high period of the SCL pulse. Changes in SDA while SCL is high are control signals (see the START and STOP Conditions section). SDA and SCL idle high when the I²C bus is not busy.

START and STOP Conditions

A master device initiates communication by issuing a START condition. A START condition is a high to low transition on SDA with SCL high. A STOP condition is a low to high transition on SDA while SCL is high (Figure 4). A START (S) condition from the master signals the beginning of a transmission to the MAX9744. The master terminates transmission, and frees the bus, by issuing a STOP (P) condition. The bus remains active if a Repeated START (Sr) condition is generated instead of a STOP condition.

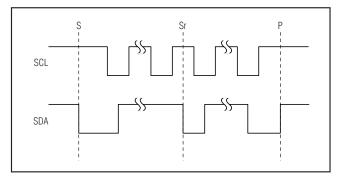


Figure 4. START, STOP, and Repeated START Conditions

Table 3. Slave Address Block

SA7 (MSB)	SA6	SA5	SA4	SA3	SA2	SA1	SA0 (LSB)
1	0	0	1	0	ADDR2	ADDR1	R/W

Table 4. Slave Address

ADDR2	ADDR1	SLAVE ADDRESS
0	0	I ² C disabled
0	1	1001001_
1	0	1001010_
1	1	1001011_

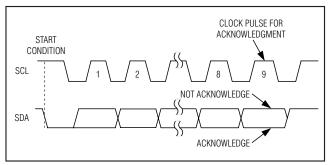
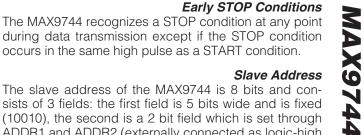


Figure 5. Acknowledge



The slave address of the MAX9744 is 8 bits and consists of 3 fields: the first field is 5 bits wide and is fixed (10010), the second is a 2 bit field which is set through ADDR1 and ADDR2 (externally connected as logic-high or logic-low), and the third field is a R/W flag bit. Set $R\overline{W} = 0$ to write to the slave. A representation of the slave address is shown in Table 3.

When ADDR1 and ADDR2 are connected to GND, serial interface communication is disabled. Table 4 summarizes the slave address of the device as a function of ADDR1 and ADDR2.

Acknowledge

The acknowledge bit (ACK) is a clocked 9th bit that the MAX9744 uses to handshake receipt of each byte of data (see Figure 5). The MAX9744 pulls down SDA during the master-generated 9th clock pulse. The SDA line must remain stable and low during the high period of the acknowledge clock pulse. Monitoring ACK allows for detection of unsuccessful data transfers. An unsuccessful data transfer occurs if a receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the bus master may reattempt communication.

MIXIM

MAX9744

Write Byte

A write to the MAX9744 includes transmission of a START condition, the slave address with the R/W bit set to 0 (see Table 3), one byte of data to the command register, and a STOP condition. Figure 6 illustrates the proper format for one frame.

A write to the MAX9744 consists of a 6-step sequence as seen below:

- 1) The **master** sends a START condition.
- 2) The **master** sends the 7 bits slave ID plus a write bit (low).
- 3) The addressed **slave** asserts an ACK on the data line.
- 4) The master sends 8 data bits.
- 5) The active **slave** asserts an ACK (or NACK) on the data line.
- 6) The master generates a stop condition.

Speaker Volume Control

The command register is used to control the volume level of the speaker amplifier. The two MSBs (A1 and A0) are set to 00, while V5–V0 is the data that is written into the addresses register to set the volume level (Tables 5 and 6).

Table 5. Data Byte Format

D7 (MSB)	D6	D5	D4	D3	D2	D1	D0 (LSB)
A1	AO	V5	V4	V3	V2	V1	VO

Table 6. Command Register Programming

A ₀ A ₁	V5–V0	SETTING
00	XXXXXX	Volume level (Table 7)
01	000000	Filterless modulation
01	000001	Classic PWM

A ₀ A ₁	V5–V0	SETTING
10	XXXXXX	Reserved
11	000100	Increased volume
11	000101	Decreased volume

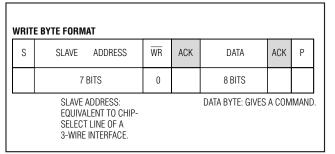


Figure 6. Write Byte Format Example

Filterless Modulation/PWM

The MAX9744 features two output modulation schemes: filterless modulation or classic PWM, selectable through the I²C interface. Table 6 shows the register command to set the output scheme.

When switching between schemes, the output is not click-and-pop protected. To have click-and-pop protection when switching between output schemes, the device must enter shutdown mode and be configured to the new output scheme before the 220ms startup sequence is terminated.

Table 7. Speaker Volume Levels

VE	V5 V4 V3		Vo	1/4	Vo	VOLUME	SDA/VOL	VOLUME
V5	V4	V3	V2	V1	V0	POSITION	VOLUME INPUT VOLTAGE (V)	ATTENUATION (dB)
1	1	1	1	1	1	63	0.100 x V _{DD}	9.5
1	1	1	1	1	0	62 0.113 x V _{DD}		8.8
1	1	1	1	0	1	61	0.125 x V _{DD}	8.2
1	1	1	1	0	0	60	0.138 x V _{DD}	7.6
1	1	1	0	1	1	59	0.151 x V _{DD}	7.0
1	1	1	0	1	0	58	0.163 x V _{DD}	6.5
1	1	1	0	0	1	57	0.176 x V _{DD}	5.9
1	1	1	0	0	0	56	0.189 x V _{DD}	5.4
1	1	0	1	1	1	55	0.202 x V _{DD}	4.9
1	1	0	1	1	0	54	0.214 x V _{DD}	4.4
1	1	0	1	0	1	53	0.227 x V _{DD}	3.9
1	1	0	1	0	0	52	0.240 x V _{DD}	3.4
1	1	0	0	1	1	51	0.252 x V _{DD}	2.9
1	1	0	0	1	0	50	0.265 x V _{DD}	2.4
1	1	0	0	0	1	49	0.278 x V _{DD}	2.0
1	1	0	0	0	0	48	0.290 x V _{DD}	1.6
1	0	1	1	1	1	47	0.303 x V _{DD}	1.2
1	0	1	1	1	0	46	0.316 x V _{DD}	0.5
1	0	1	1	0	1	45	0.329 x V _{DD}	-0.5
1	0	1	1	0	0	44	0.341 x V _{DD}	-1.9
1	0	1	0	1	1	43	0.354 x V _{DD}	-3.4
1	0	1	0	1	0	42	0.367 x V _{DD}	-5.0
1	0	1	0	0	1	41	0.379 x V _{DD}	-6.0
1	0	1	0	0	0	40	0.392 x V _{DD}	-7.1
1	0	0	1	1	1	39	0.405 x V _{DD}	-8.9
1	0	0	1	1	0	38	0.417 x V _{DD}	-9.9
1	0	0	1	0	1	37	0.430 x V _{DD}	-10.9
1	0	0	1	0	0	36	0.443 x V _{DD}	-12.0
1	0	0	0	1	1	35	0.456 x V _{DD}	-13.1
1	0	0	0	1	0	34	0.468 x V _{DD}	-14.4
1	0	0	0	0	1	33	0.481 x V _{DD}	-15.4
1	0	0	0	0	0	32	0.494 x V _{DD}	-16.4

	V5 V4 V3		1/0	1/4	Vo	VOLUME	SDA/VOL	VOLUME		
V5	V4	V3	V2	V1	V0	POSITION	VOLUME INPUT VOLTAGE (V)	ATTENUATION (dB)		
0	1	1	1	1	1	31	0.506 x V _{DD}	-17.5		
0	1	1	1	1	0	30	0.519 x V _{DD}	-19.7		
0	1	1	1	0	1	29	0.532 x V _{DD}	-21.6		
0	1	1	1	0	0	28	0.544 x V _{DD}	-23.5		
0	1	1	0	1	1	27	0.557 x V _{DD}	-25.2		
0	1	1	0	1	0	26	0.570 x V _{DD}	-27.2		
0	1	1	0	0	1	25	0.583 x V _{DD}	-29.8		
0	1	1	0	0	0	24	0.595 x V _{DD}	-31.5		
0	1	0	1	1	1	23	0.608 x V _{DD}	-33.4		
0	1	0	1	1	0	22	0.621 x V _{DD}	-36.0		
0	1	0	1	0	1	21	0.633 x V _{DD}	-37.6		
0	1	0	1	0	0	20	0.646 x V _{DD}	-39.6		
0	1	0	0	1	1	19	0.659 x V _{DD}	-42.1		
0	1	0	0	1	0	18	0.671 x V _{DD}	-43.7		
0	1	0	0	0	1	17	0.684 x V _{DD}	-45.6		
0	1	0	0	0	0	16	0.697 x V _{DD}	-48.1		
0	0	1	1	1	1	15	0.710 x V _{DD}	-50.6		
0	0	1	1	1	0	14	0.722 x V _{DD}	-54.2		
0	0	1	1	0	1	13	0.735 x V _{DD}	-56.7		
0	0	1	1	0	0	12	0.748 x V _{DD}	-60.2		
0	0	1	0	1	1	11	0.760 x V _{DD}	-62.7		
0	0	1	0	1	0	10	0.773 x V _{DD}	-66.2		
0	0	1	0	0	1	9	0.786 x V _{DD}	-68.7		
0	0	1	0	0	0	8	0.798 x V _{DD}	-72.2		
0	0	0	1	1`	1	7	0.811 x V _{DD}	-74.7		
0	0	0	1	1	0	6	0.824 x V _{DD}	-78.3		
0	0	0	1	0	1	5	0.837 x V _{DD}	-80.8		
0	0	0	1	0	0	4	0.849 x V _{DD}	-84.3		
0	0	0	0	1	1	3	0.862 x V _{DD}	-86.8		
0	0	0	0	1	0	2	0.875 x V _{DD}	-90.3		
0	0	0	0	0	1	1	0.887 x V _{DD}	-92.8		
0	0	0	0	0	0	0	0.900 x V _{DD}	MUTE		

Table 7. Speaker Volume Levels (continued)

Applications Information

Filterless Class D Operation

The MAX9744 meets common EMC radiation limits without a filter when the speaker leads are less than approximately 10cm. Using lengths beyond 10cm is possible verifying against the appropriate EMC standard.

For longer speaker wire lengths, up to approximately 1m, use a simple ferrite bead and capacitor filter to meet EMC limits. Select a ferrite bead with 100Ω to 600Ω impedance, and rated for at least 3A. The capacitor value varies based on the ferrite bead chosen and the actual speaker lead length. Select the capacitor value based on EMC performance. See Figure 7 for the correct connections of these components.

When evaluating the device without a filter or a ferrite bead filter, include a series inductor (68µH for 8 Ω load and 33µH for 4 Ω load) to model the actual loudspeaker's behavior. Omitting this inductor reduces the efficiency, the THD+N performance, and the output power of the MAX9744.

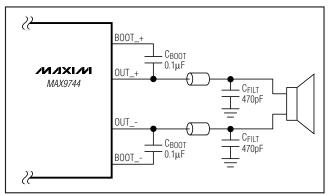


Figure 7. Ferrite Bead Filter

Inductor-Based Output Filters

Some applications use the MAX9744 with a full inductor/capacitor-based (LC) output filter. This is common for longer speaker lead lengths and to gain increased margin to EMC limits. Select the PWM output mode and use fixed-frequency modulation mode for best audio performance. See Figure 8 for the correct connections of these components.

The component selection is based on the load impedance of the speaker. Table 8 lists suggested values for a variety of load impedances.

Inductors L1 and L2 and capacitor C1 form the primary output filter. In addition to these primary filter components, other components in the filter improve its functionality. Capacitors C4 and C5 plus resistors R1 and R2 form a Zobel at the output. A Zobel corrects the output loading to compensate for the rising impedance of the loudspeaker. Without a Zobel, the filter has a peak in its response near the cutoff frequency. Capacitors C2 and C3 provide common-mode noise suppression to reduce radiated emissions.

Table 8. Suggested Values for LC filter

R L (Ω)	L1, L2 (µH)	C1 (µF)	C2, C3 (μF)	R1, R2 (Ω)	C4, C5 (μF)
4	10	0.47	0.47	10	0.47
6	15	0.33	0.22	15	0.33
8	22	0.22	0.22	22	0.22

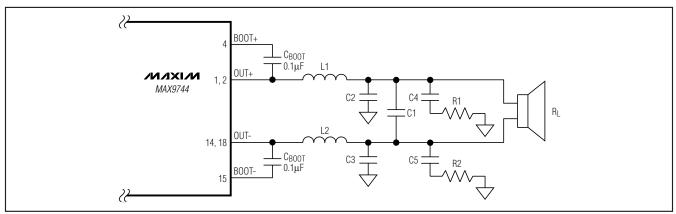


Figure 8. Output Filter for PWM Mode

Component Selection

Gain-Setting Resistors

External feedback resistors set the gain of the MAX9744. The output stage has an internal 20dB gain in addition to the externally set input stage gain. Set the maximum gain by using resistors R_F and R_{IN} (Figure 9) as follows:

$$A_V = -30 \left(\frac{R_F}{R_{IN}}\right) V \ / \ V$$

Choose R_F between $10k\Omega$ and $50k\Omega$. Note that the actual gain of the amplifier is dependent on the volume level setting. For example, with the volume set to +9.5dB, the amplifier gain would be 9.5dB plus 20dB, assuming R_{IN} = R_F.

The input amplifier can be configured into a variety of circuits. The FB terminal is an actual operational amplifier output, allowing the MAX9744 to be configured as a summing amplifier, a filter, or an equalizer, for example.

Input Capacitor

An input capacitor (C_{IN}) in conjunction with the input impedance of the MAX9744 form a highpass filter that removes the DC bias from an incoming signal. The ACcoupling capacitor allows the amplifier to automatically bias the signal to an optimum DC level. Assuming zero source impedance, the -3dB point of the highpass filter is given by:

$$f_{-3dB} = \frac{1}{2\pi R_{IN}C_{IN}}$$

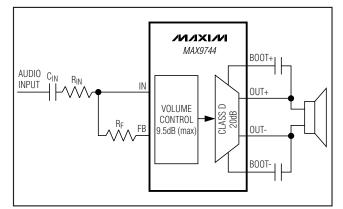


Figure 9. Setting Gain

Choose C_{IN} that f_{-3dB} is well below the lowest frequency of interest. Use capacitors whose dielectrics have low-voltage coefficients, such as tantalum or aluminum electrolytic. Capacitors with high-voltage coefficients, such as ceramics, may result in increased distortion at low frequencies.

DC-Coupled Input

The input amplifier can accept DC-coupled inputs that are biased to the amplifier's bias voltage. DC-coupling eliminates input-coupling capacitors, reducing component count to potentially one external component. In this configuration the highpass filtering effect of the capacitors is lost, allowing low-frequency signals to be amplified.

Power Supplies

The MAX9744 features separate supplies for each portion of the device, allowing for the optimum combination of headroom power dissipation and noise immunity. The speaker amplifier is powered from PVDD and can range from 4.5V to 14V. The remainder of the device is powered by V_{DD}. Power supplies are independent of each other so sequencing is not necessary. Power may be supplied by separate sources or derived from a single higher source using a linear regulator (Figure 10).

BIAS Capacitor

BIAS is the output of the internally generated DC bias voltage. The BIAS bypass capacitor, C_{BIAS} , improves PSRR and THD+N by reducing power supply and other noise sources at the common-mode bias node, and also generates the clickless/popless, startup/shutdown, DC bias waveforms for the speaker amplifiers. Bypass BIAS with a 2.2µF capacitor to GND.

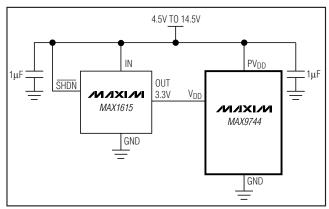


Figure 10. Using a Linear Regulator to Produce 3.3V from a Higher Power Supply



AX9744

Supply Bypassing, Layout, and Grounding

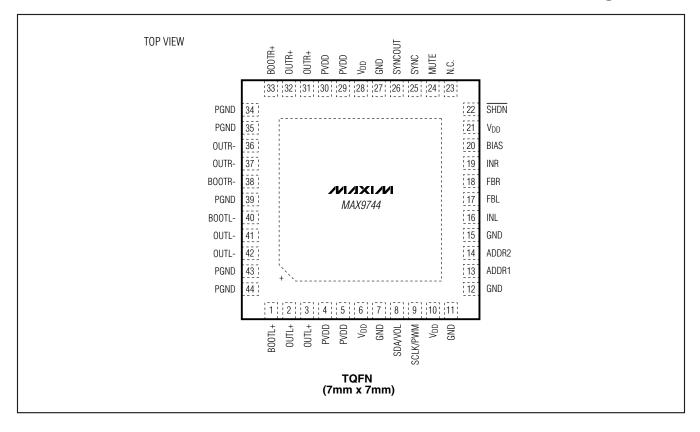
Proper layout and grounding are essential for optimum performance. Use large traces for the power-supply inputs and amplifier outputs to minimize losses due to parasitic trace resistance. Large traces also aid in moving heat away from the package. Proper grounding improves audio performance, minimizes crosstalk between channels, and prevents any switching noise from coupling into the audio signal. Connect PGND and GND together at a single point on the PCB. Route all traces that carry switching transients away from GND and the traces/components in the audio signal path.

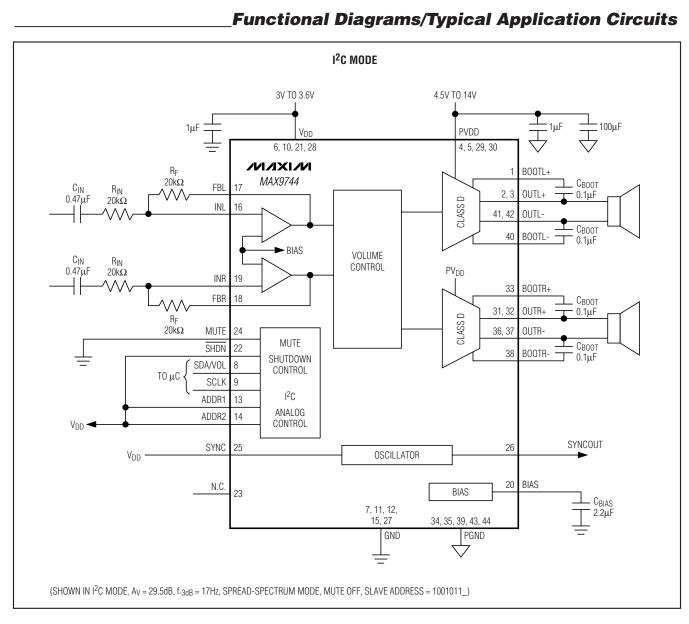
Connect all PVDD power supplies together and bypass with a 1μ F capacitor to PGND. Connect all V_{DD} power supplies together and bypass with a 1μ F capacitor to GND. Place a bulk capacitor between PVDD and PGND if needed.

Use large, low-resistance output traces. Current drawn from the outputs increase as load impedance decreases. High output trace resistance decreases the power delivered to the load. Large output, supply, and GND traces allow more heat to move from the MAX9744 to the air, decreasing the thermal impedance of the circuit.

The MAX9744 thin QFN package features an exposed thermal pad on its underside. This pad lowers the package's thermal resistance by providing a direct heat conduction path from the die to the PCB. Connect the exposed thermal pad to PGND by using a large pad and multiple vias to the PGND plane. The exposed pad must be connected to PGND for proper device operation.

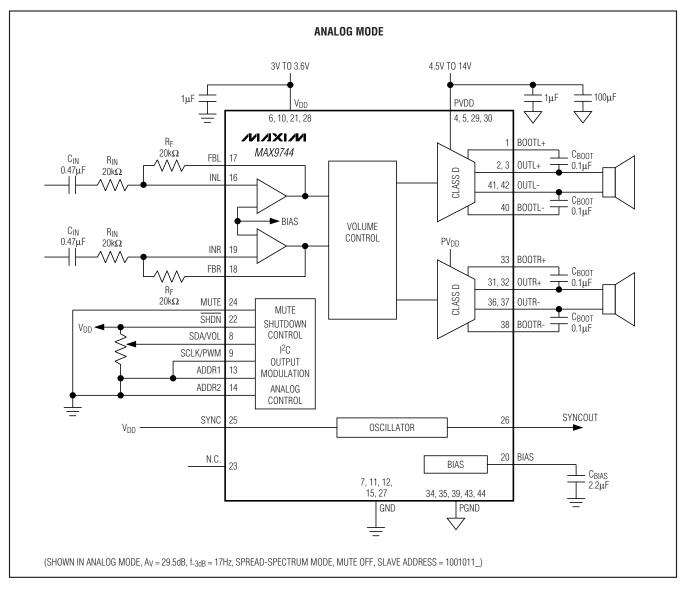
Pin Configuration





MAX9744

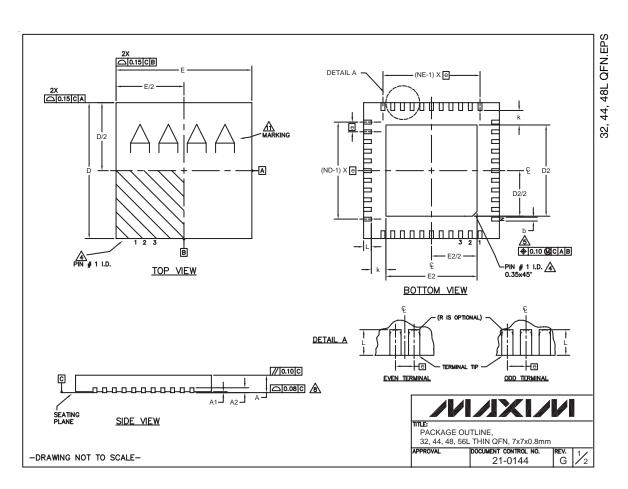
Functional Diagrams/Typical Application Circuits (continued)



MAX9744

Package Information

For the latest package outline information and land patterns, go to <u>www.maxim-ic.com/packages</u>.



MAX9744

Package Information (continued)

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages.

					COM	IMON [IMENSI	ons										EXPOS	ed pai) varia	ATIONS				
				CUSTOM PKG. (T4877-1)			PKG. CODES	DEPOPULATED	ED D2 MIN. NOM. MAX.			E2 K. MIN. NOM. MAX.			JEDEC MO220 REV. C										
PKG		32L 7x	7	4	4L 7x7	,	4	18L 7x7	,	4	8L 7x	7	:	56L 7x	7	T3277-2	-	4.55		4.85	4.55		4.85	- KEV. C	
YMBOL	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	T3277-3	-	4.55	4.70	4.85	4.55		4.85	-	
A	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	T4477-2	-	4.55	4.70	4.85	4.55	4.70	4.85	WKKD-1	
A1	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05	0	-	0.05	T4477-3	-	4.55	4.70	4.85	4.55	4.70	4.85	WKKD-1	
A2).20 RE			.20 RE		(0.20 RE		6	.20 R	-).20 RE	-	T4877-1**	13,24,37,48	4.20	4.30	4.40	4.20	4.30	4.40	-	
b	0.25	0.30	0.35	0.20	0.25	0.30	0.20	0.25	0.30	0.20	0.25	0.30	0.15	0.20	0.25	T4877-3	-	4.95	5.10	5.25	4.95	5.10	5.25	-	
D		7.00									7.00			7.00		T4877-4	-	5.40	5.50	5.60	5.40	5.50	5.60	-	
E		7.00									7.00			7.00		T4877-5	-	2.40	2.50	2.60	2.40	2.50	2.60	-	
e	-).65 BS	-	i	.50 BS).50 BS			.50 BS		1).40 BS	-	T4877-6	-	5.40	5.50	5.60	5.40	5.50	5.60	-	
k	0.25	-	-	0.25	-	-	0.25	-	-	0.25	-	-	0.25	-	-	T4877-7	-		5.10	5.25	4.95	5.10	5.25	-	
Ľ	0.45	0.55	0.65	0.45	0.55	0.65		0.40	0.50		0.55	0.65	0.30	0.40	0.50	T4877M-1	-	5.40			5.40			-	
N		32			44			48			44	1		56		T4877M-6	-	5.40	5.50	5.60	5.40		5.60	-	
ND		8			11			12			10			14		T4877MN-8	-	5.40			5.40		5.60	-	
NE		8			11			12				<u> </u>			T4877N-8	-	5.40	5.50	5.60	5.40		5.60	-		
NL.	1	<u> </u>								14															
NOTE										I	12		I	14		T5677-1 T5677-2 ** NOTE: T48			5.50 M 48L	5.60 PKG.		5.50	5.60	- EPOPULA	TED.
1.	DIMEI ALL I N IS THE SPP THE DIMEI 0.25 ND A DEPC COPL DRAW	DIMEN THE TERMII -012. ZONE NSION 5 mm ND Ni 0PULA	SIONS TOTAL DET INDIC AND E REF TON IS TY API	ARE NUME AILS CATED. PLIES 0.30 ER TO S POS PLIES RMS 1	RANCII IN MIL BER O NTIFIE DF TE THE TO M mm F THE SIBLE TO TH O JEL	LIMET F TER R AND RMINA TERMI ETALL ROM NUME IN A HE EX DEC M	ERS. MINAL TERM L #1 NAL # ZED TERMI DER 0 SYMM POSEL 0220	M TO ANGLE S. //INAL IDENT IDENT IERMIN NAL T F TER IETRIC D HEA EXCE	s are Numb Ifier Ifier Ial at IP. Minal: AL FA Sint	E IN E ERING ARE (R MA ND IS S ON SHION (SLU	5M-19 DEGRE DPTION Y BE MEAS EACH G AS	ES. VENTIC VAL, B EITHE SURED D AN WELL	NUT MU RAN BETW NDE AST	ALL C JST B IOLD C EEN SIDE I	e loca or mar Respec	T5677-2 •• NOTE: T46 TOT 4 TO JESD 95 TED WITHIN tkED FEATURE. TIVELY.	AL NUMBER (5.40 :USTO	5.50 M 48L	5.60 PKG.	5.40 WITH	5.50	5.60	-	TED

Chip Information

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
44 TQFN-EP	T4477-3	<u>21-0144</u>

PROCESS: BICMOS

MAX9744

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	3/08	Initial release	—
1	9/08	Updated EC table for single pass flow	2, 4, 5

Revision History

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

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